74LVC109

Dual JK flip-flop with set and reset; positive-edge trigger Rev. 5 — 29 November 2012 Product data

Product data sheet

General description 1.

The 74LVC109A is a dual positive edge triggered $J\overline{K}$ flip-flop featuring:

- individual J and K inputs
- clock (CP) inputs
- set (SD) and reset (RD) inputs
- complementary Q and Q outputs

The set and reset are asynchronous active LOW inputs and operate independently of the clock input.

The J and K inputs control the state changes of the flip-flops as described in the mode select function table. The J and \overline{K} inputs must be stable one set-up time before the LOW-to-HIGH clock transition for predictable operation. The JK design allows operation as a D-type flip-flop by tying the J and K inputs together.

Schmitt trigger action in the clock input makes the circuit highly tolerant of slower clock rise and fall times.

Features and benefits 2.

- 5 V tolerant inputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ♦ HBM JESD22-A114F exceeds 2000 V
 - ♦ MM JESD22-A115-B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



Dual JK flip-flop with set and reset; positive-edge trigger

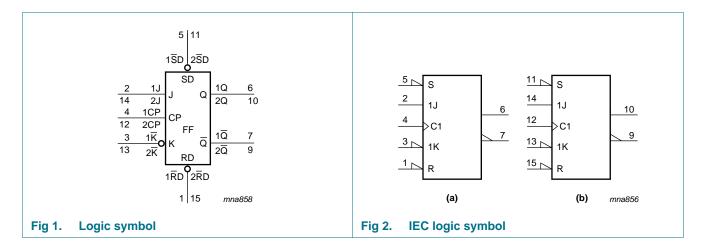
3. Ordering information

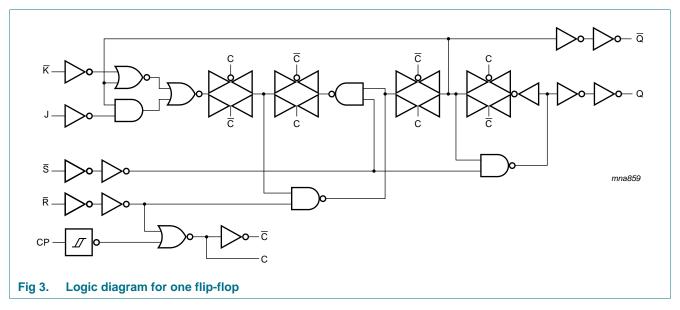
Table 1. Ordering information

All types are specified from -40 °C to +125 °C.

Type number	Package	Package						
	Name	Description	Version					
74LVC109D	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1					
74LVC109DB	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1					
74LVC109PW	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1					

4. Functional diagram

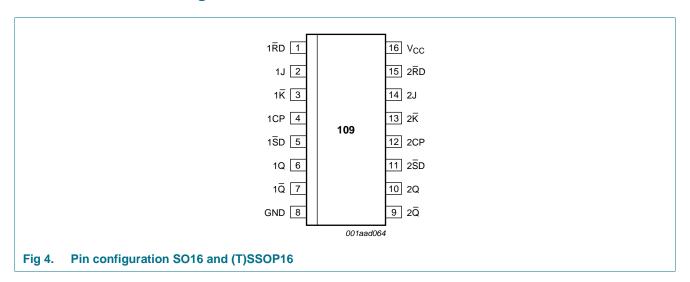




Dual JK flip-flop with set and reset; positive-edge trigger

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1RD	1	asynchronous reset input (active LOW)
1J	2	synchronous input
1K	3	synchronous input
1CP	4	clock input (LOW-to-HIGH; edge-triggered)
1SD	5	asynchronous set input (active LOW)
1Q	6	true flip-flop output
1Q	7	complement flip-flop output
GND	8	ground (0 V)
2Q	9	complement flip-flop output
2Q	10	true flip-flop output
2SD	11	asynchronous set input (active LOW)
2CP	12	clock input (LOW-to-HIGH; edge-triggered)
2K	13	synchronous input
2J	14	synchronous input
2RD	15	asynchronous reset input (active LOW)
V _{CC}	16	supply voltage

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6. Functional description

Table 3. Function selection[1]

Operating modes	Input						Output	
	nSD	nRD	nCP	nJ	nK	nQ	nQ	
Asynchronous set	L	Н	X	Χ	Χ	Н	L	
Asynchronous reset	Н	L	Χ	Х	Х	L	Н	
Undetermined	L	L	Χ	Х	Х	Н	Н	
Toggle	Н	Н	↑	h	I	q	q	
Load 0 (reset)	Н	Н	↑	I	I	L	Н	
Load 1 (set)	Н	Н	↑	h	h	Н	L	
Hold no change	Н	Н	↑	I	h	q	q	

^[1] H = HIGH voltage level

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
V _I	input voltage		[<u>1</u>] -0.5	+6.5	V
I _{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0$ V	-	±50	mA
V _O	output voltage		[2] -0.5	$V_{CC} + 0.5$	V
I _O	output current	$V_O = 0 V to V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I_{GND}	ground current		-100	-	mA
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	<u>[3]</u> _	500	mW
T_{stg}	storage temperature		-65	+150	°C

^[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

h = HIGH voltage level one set-up time before the LOW-to-HIGH CP transition

L = LOW voltage level

I = LOW voltage level one set-up time before the LOW-to-HIGH CP transition

q = lower case letters indicate the state of the referenced output one set-up time before the LOW-to-HIGH CP transition

X = don't care

^{↑ =} LOW-to-HIGH CP transition

^[2] The output voltage ratings may be exceeded if the output current ratings are observed.

^[3] For SO16 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K. For (T)SSOP16 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K.

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8. Recommended operating conditions

Table 5. Recommended operating conditions

Parameter	Conditions	Min	Тур	Max	Unit
supply voltage		1.65	-	3.6	V
	functional	1.2	-	-	V
input voltage		0	-	5.5	V
output voltage		0	-	V_{CC}	V
ambient temperature	in free air	-40	-	+125	°C
input transition rise and fall rate	$V_{CC} = 1.65 \text{ V to } 2.7 \text{ V}$	0	-	20	ns/V
	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	0	-	10	ns/V
	supply voltage input voltage output voltage ambient temperature	$\begin{tabular}{ll} supply voltage & & & \\ \hline functional & & \\ \hline input voltage & & \\ \hline output voltage & & \\ \hline ambient temperature & in free air \\ \hline input transition rise and fall rate & $V_{CC} = 1.65 \ V$ to 2.7 \ V$ \\ \hline \end{tabular}$	$\begin{array}{c} \text{supply voltage} & 1.65 \\ \hline \text{functional} & 1.2 \\ \hline \text{input voltage} & 0 \\ \hline \text{output voltage} & 0 \\ \hline \text{ambient temperature} & \text{in free air} & -40 \\ \hline \text{input transition rise and fall rate} & V_{\text{CC}} = 1.65 \text{ V to } 2.7 \text{ V} & 0 \\ \hline \end{array}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	35 °C	-40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
V _{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	٧
	input voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	٧
		V _{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	٧
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
c	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}						
		$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	V _{CC} - 0.2	-	-	$V_{CC}-0.3$	-	V
		$I_O = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	٧
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	٧
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	٧
V_{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	-	-	0.2	-	0.3	V
		$I_O = 4 \text{ mA}$; $V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	٧
		$I_O = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
lı	input leakage current	V_{CC} = 3.6 V; V_I = 5.5 V or GND	-	±0.1	±5	-	±20	μΑ

Dual JK flip-flop with set and reset; positive-edge trigger

 Table 6.
 Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Symbol Parameter Conditions		-40	-40 °C to +85 °C			+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
I _{CC}	supply current	$V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND};$ $I_O = 0 \text{ A}$	-	0.1	10	-	40	μΑ
ΔI_{CC}	additional	per input pin;	-	5	500	-	5000	μΑ
	supply current	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V};$ $V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A}$						
C _I	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_I = \text{GND to } V_{CC}$	-	5.0	-	-	-	pF

^[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 7</u>.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation	nCP to nQ, nQ; see Figure 5	[2]				1		
	delay	V _{CC} = 1.2 V		-	15	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		1.7	6.8	15.0	1.7	17.4	ns
		V _{CC} = 2.3 V to 2.7 V		2.7	3.9	8.1	2.7	9.4	ns
		V _{CC} = 2.7 V		1.5	3.9	7.3	1.5	9.5	ns
		V _{CC} = 3.0 V to 3.6 V		1.0	3.5	6.8	1.0	8.5	ns
	LOW to HIGH propagation delay	$n\overline{S}D$, $n\overline{R}D$ to nQ , $n\overline{Q}$; see Figure 6							
		V _{CC} = 1.2 V		-	16	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		1.0	6.2	15.6	1.0	18.0	ns
		V _{CC} = 2.3 V to 2.7 V		1.5	3.6	8.3	1.5	9.7	ns
		V _{CC} = 2.7 V		1.5	4.5	8.2	1.5	10.5	ns
		V _{CC} = 3.0 V to 3.6 V		1.0	3.3	7.0	1.0	9.0	ns
PHL	HIGH to	$n\overline{S}D$, $n\overline{R}D$ to nQ , $n\overline{Q}$; see Figure 6							
	LOW propagation	V _{CC} = 1.2 V		-	13	-	-	-	ns
	delay	V _{CC} = 1.65 V to 1.95 V		1.5	6.7	14.4	1.5	16.7	ns
	•	V_{CC} = 2.3 V to 2.7 V		2.0	3.8	7.7	2.0	9.0	ns
		V _{CC} = 2.7 V		1.5	4.1	7.1	1.5	9.0	ns
		V _{CC} = 3.0 V to 3.6 V		1.0	3.5	6.5	1.0	8.5	ns

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Table 7. Dynamic characteristics ...continued Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

Symbol	Parameter	Conditions	-40	-40 °C to +85 °C			-40 °C to +125 °C	
			Min	Typ[1]	Max	Min	Max	
t _W	pulse width	clock HIGH or LOW; see Figure 5	•	•				
		V _{CC} = 1.65 V to 1.95 V	5.0	-	-	5.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	4.0	-	-	4.0	-	ns
		V _{CC} = 2.7 V	3.3	-	-	3.3	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	3.3	2.0	-	3.3	-	ns
		set or reset HIGH or LOW; see Figure 6						
		V _{CC} = 1.65 V to 1.95 V	5.0	-	-	5.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	4.0	-	-	4.0	-	ns
		V _{CC} = 2.7 V	3.0	-	-	3.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	3.0	-	-	3.0	-	ns
t _{rec}	recovery	nSD, nRD to nCP; see Figure 6						
	time	V _{CC} = 1.65 V to 1.95 V	5.5	-	-	5.5	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 \text{ V}$	3.2	-	-	3.2	-	ns
		V_{CC} = 3.0 V to 3.6 V	3.0	-	-	3.0	-	ns
t _{su}	set-up time	nJ and nK to CP; see Figure 5						
		V _{CC} = 1.65 V to 1.95 V	5.0	-	-	5.0	-	ns
		V_{CC} = 2.3 V to 2.7 V	3.5	-	-	3.5	-	ns
		$V_{CC} = 2.7 \text{ V}$	2.7	-	-	2.7	-	ns
		V_{CC} = 3.0 V to 3.6 V	2.5	-	-	2.5	-	ns
t _h	hold time	nJ and nK to nCP; see Figure 5						
		V _{CC} = 1.65 V to 1.95 V	3.0	-	-	3.0	-	ns
		V_{CC} = 2.3 V to 2.7 V	2.5	-	-	2.5	-	ns
		$V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.2	-	ns
		V_{CC} = 3.0 V to 3.6 V	2.0	-	-	2.0	-	ns
: max	maximum	see Figure 5						
	frequency	V _{CC} = 1.65 V to 1.95 V	100	-	-	80	-	MH
		V_{CC} = 2.3 V to 2.7 V	125	-	-	100	-	MH
		V _{CC} = 2.7 V	150	-	-	120	-	MH
		V _{CC} = 3.0 V to 3.6 V	150	330	-	120	-	MH
sk(o)	output skew time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	<u> </u>	-	1.0	-	1.5	ns
C _{PD}	power	$V_I = GND \text{ to } V_{CC}$	<u>1]</u>					
	dissipation	V _{CC} = 1.65 V to 1.95 V	-	11.4	-	-	-	pF
	capacitance	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	17.6	-	-	-	pF
		V _{CC} = 3.0 V to 3.6 V	-	23.1	-	_	-	pF

^[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

^[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

^[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

Dual JK flip-flop with set and reset; positive-edge trigger

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

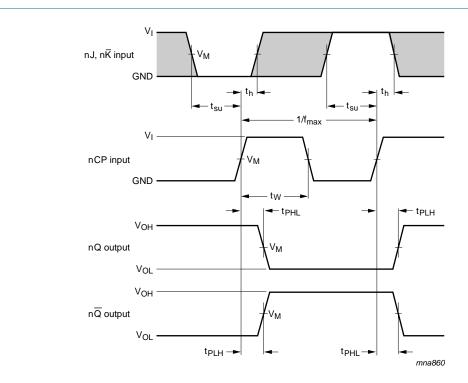
 C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs

11. AC waveforms



Measurement points are given in Table 8.

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

The shaded areas indicate when the input is permitted to change for predictable output performance.

Fig 5. Clock propagation delays, pulse width, set-up, hold times, and maximum frequency

Dual JK flip-flop with set and reset; positive-edge trigger

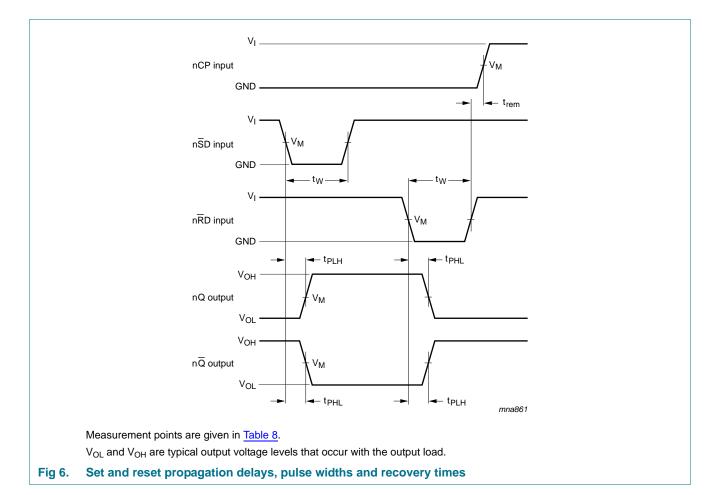
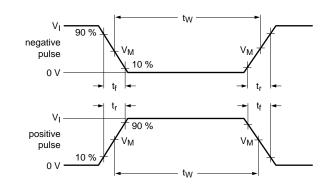
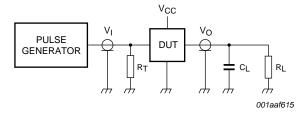


Table 8. Measurement points

Supply voltage	Input	Output	
V _{CC}	V _I	V _M	V _M
1.2 V	V _{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
1.65 V to 1.95 V	V _{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
2.3 V to 2.7 V	V _{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
2.7 V	2.7 V	1.5 V	1.5 V
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V

Dual JK flip-flop with set and reset; positive-edge trigger





Test data is given in Table 9.

Definitions for test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

Fig 7. Load circuitry for switching times

Table 9. Test data

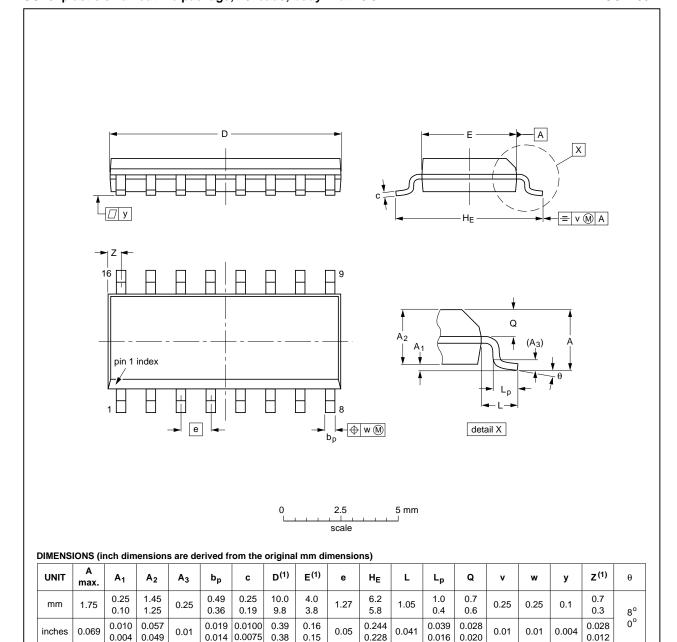
Supply voltage	Input		Load		
	V _I	t _r , t _f	C _L	R _L	
1.2 V	V _{CC}	≤ 2 ns	30 pF	1 kΩ	
1.65 V to 1.95 V	V _{CC}	≤ 2 ns	30 pF	1 kΩ	
2.3 V to 2.7 V	V _{CC}	≤ 2 ns	30 pF	500 Ω	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	

Dual JK flip-flop with set and reset; positive-edge trigger

12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT109-1	076E07	MS-012			99-12-27 03-02-19

Fig 8. Package outline SOT109-1 (SO16)

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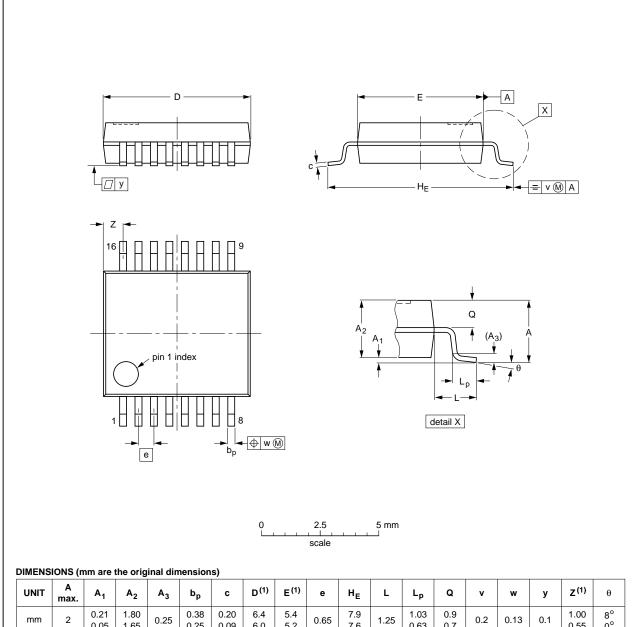
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74LVC109 **NXP Semiconductors**

Dual JK flip-flop with set and reset; positive-edge trigger

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



UNIT	A max.	A ₁	A ₂	A ₃	b _p	C	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	٧	w	у	Z ⁽¹⁾	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

	OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE		
	SOT338-1		MO-150				99-12-27 03-02-19	

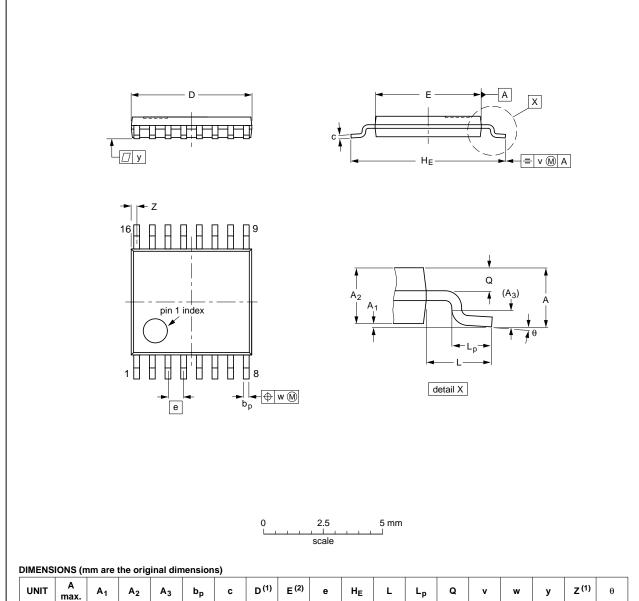
Fig 9. Package outline SOT338-1 (SSOP16)

74LVC109

Dual JK flip-flop with set and reset; positive-edge trigger

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



-							-,												
	UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
	mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE		
SOT403-1		MO-153			99-12-27 03-02-18		
					-		

Fig 10. Package outline SOT403-1 (TSSOP16)

74LVC10

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Dual JK flip-flop with set and reset; positive-edge trigger

13. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes						
74LVC109 v.5	20121129	Product data sheet	-	74LVC109 v.4						
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 									
	 Legal texts ha 	ve been adapted to the new	company name where	appropriate.						
	• Table 4, Table	5, Table 6, Table 7 and Table	8: values added for lo	ower voltage ranges.						
74LVC109 v.4	20040318	Product specification	-	74LVC109 v.3						
74LVC109 v.3	19980428	Product specification	-	74LVC109 v.2						
74LVC109 v.2	19970318	Product specification	-	74LVC109 v.1						
74LVC109 v.1	-	-	-	-						

Dual JK flip-flop with set and reset; positive-edge trigger

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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